onsemi

MOSFET – Power, Dual, N-Channel With ESD Protection, SC-88 60 V, 295 mA NTJD5121N, NVJD5121N Features

• Low R_{DS(on)}

- Low Gate Threshold
- Low Input Capacitance
- ESD Protected Gate
- NVJD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This is a Pb–Free Device

Applications

- Low Side Load Switch
- DC-DC Converters (Buck and Boost Circuits)

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parame	Symbol	Value	Unit		
Drain-to-Source Voltage	V _{DSS}	60	V		
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	$T_A = 25^{\circ}C$	Ι _D	295	mA
Current (Note 1)	State	$T_A = 85^{\circ}C$		212	
	t ≤ 5 s	$T_A = 25^{\circ}C$		304	
		$T_A = 85^{\circ}C$		219	
Power Dissipation (Note 1)	Steady State	T _A = 25°C	PD	250	mW
	t≤5 s			266	
Pulsed Drain Current	t _p =	= 10 μs	I _{DM}	900	mA
Operating Junction and S	T _J , T _{STG}	–55 to 150	°C		
Source Current (Body Did	۱ _S	210	mA		
Lead Temperature for So (1/8" from case for 10 s)	ΤL	260	°C		
Gate-Source ESD Rating (HBM)			ESD _{HBM}	2000	V
Gate-Source ESD Rating (MM)			ESD _{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

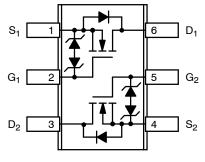
Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State	$R_{\theta JA}$	467	°C/W
Junction-to-Ambient – t \leq 5 s	$R_{\theta JA}$	412	
Junction-to-Lead - Steady State	R_{\thetaJL}	252	

1. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).

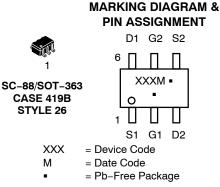
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V _{(BR)DSS}	R _{DS(on)} MAX	I _D Max	
60 V	1.6 Ω @ 10 V	295 mA	
	2.5 Ω @ 4.5 V	295 IIIA	

SC-88 (SOT-363)



Top View



(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information ion page 5 of this data sheet.

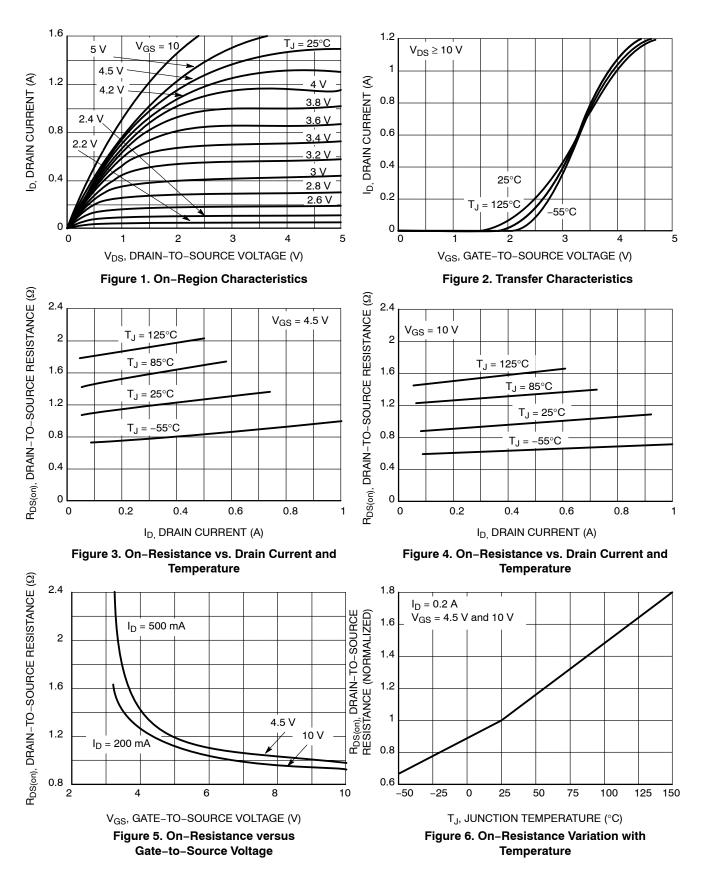
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

Parameter	Symbol	Test Cond	dition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	· ·						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 250 μA, re	ef to 25°C		92		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	μΑ
		$V_{\rm DS} = 60$ V	T _J = 125°C			500	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	_S = ±20 V			±10	μA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	1.0	1.7	2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 500 mA V_{GS} = 4.5 V, I _D = 200 mA			1.0	1.6	Ω
					1.2	2.5	
Forward Transconductance	9fs	$V_{DS} = 5 V, I_D =$	= 200 mA		80		S
Gate Resistance	R _G				536		Ω
CHARGES AND CAPACITANCES			•		•		•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 20 V			26		pF
Output Capacitance	C _{OSS}				4.4		1
Reverse Transfer Capacitance	C _{RSS}	•05			2.5		
Total Gate Charge	Q _{G(TOT)}				0.9		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V	ns = 25 V,		0.2		-
Gate-to-Source Charge	Q _{GS}	I _D = 200	mA		0.3		
Gate-to-Drain Charge	Q _{GD}				0.28		
SWITCHING CHARACTERISTICS (No	ote 3)				•	•	
Turn-On Delay Time	t _{d(on)}				22		ns
Rise Time	t _r	V _{GS} = 4.5 V, V _I	ם = 25 V.		34		
Turn–Off Delay Time	t _{d(off)}	$I_{\rm D} = 200 \text{ mA}, R_{\rm G} = 25 \Omega$			34		
Fall Time	t _f				32		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.8	1.2	V
		I _S = 200 mA	T _J = 85°C		0.7		1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 3. Switching characteristics are independent of operating junction temperatures.

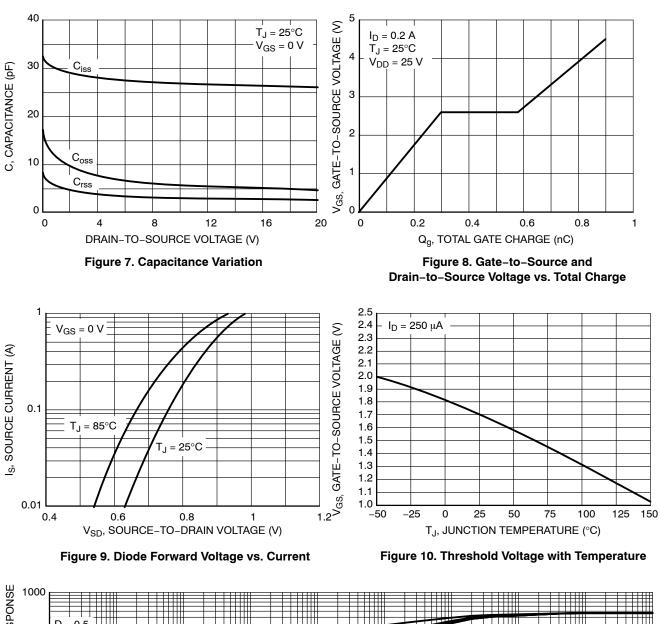
TYPICAL PERFORMANCE CURVES

 $(T_J = 25^{\circ}C \text{ UNLESS OTHERWISE NOTED})$



TYPICAL PERFORMANCE CURVES

 $(T_J = 25^{\circ}C \text{ UNLESS OTHERWISE NOTED})$



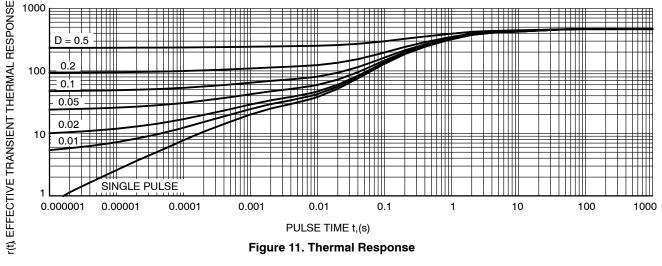


Table 1. ORDERING INFORMATION

Part Number	Marking	Package	Shipping [†]
NTJD5121NT1G	TF	SC-88 (Pb-Free)	3000 / Tape & Reel
NTJD5121NT2G	TF	SC–88 (Pb–Free)	3000 / Tape & Reel
NVJD5121NT1G*	VTF	SC-88 (Pb-Free)	3000 / Tape & Reel
NVJD5121NT1G-M06*	VTF	SC-88 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NVJD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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